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Inventor: Werner Juengling, et al.

Title: Methods of Forming Materials Between Conductive Electrical Components

and Insulating Materials

Assignee: Micron Technology, Inc.

Priority Serial No. 09/115,339

Priority Filing Date: July 14, 1998

INFORMATION DISCLOSURE STATEMENT PURSUANT TO 37 C.F.R. §§ 1.56, 1.97 AND 1.98

In compliance with 37 C.F.R. §§ 1.56, 1.97 and 1.98, your attention is directed to the United States patents and other references listed on the attached Form PTO-1449. No admission is made regarding whether all the submitted references are prior art.

The listed references were cited by, or submitted to, the Office in the parent, co-pending application of the above-identified application. The above-identified application is a divisional application of co-pending application Serial No. 09/115,339, filed July 14, 1998. Such prior disclosure is sufficient for the above-identified application as far as copies of the references are concerned. 37 C.F.R. § 1.98(d) and MPEP § 609(2).

Citation of these references is respectfully requested.

Respectfully submitted,

Dated: March 18, 2001

Attorney: WM Bernard Berman Reg. No. 37,279

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Form PTO-1449

U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE

LIST OF ART CITED BY APPLICANT (Use several sheets if necessary)

ATTY. DOCKET NO. MI22-1599

PRIORITY SERIAL N 09/115,339

APPLICANT Werner Juengling et al.

PRIORITY GROUP

PRIORITY FILING DATE July 14, 1998

U.S. PATENT DOCUMENTS

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*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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PATENT AND TRADEMARK OFFICE

MI22-1599

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Werner Juengling et al.

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